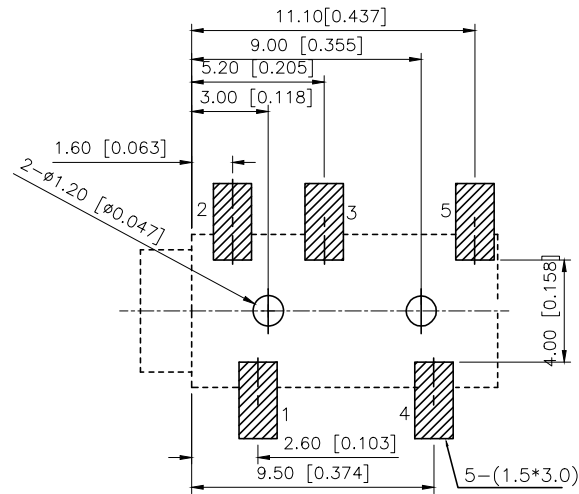
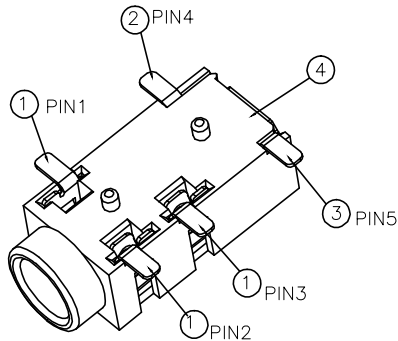
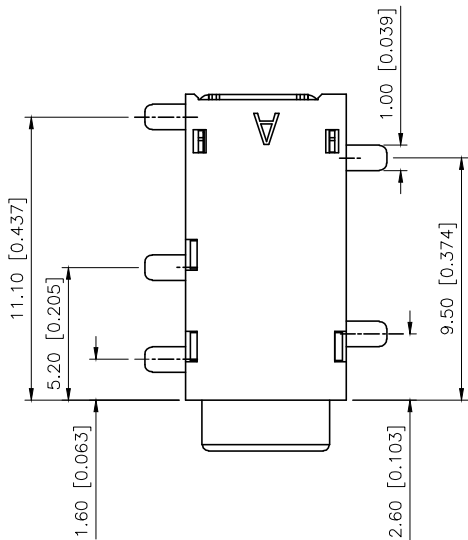
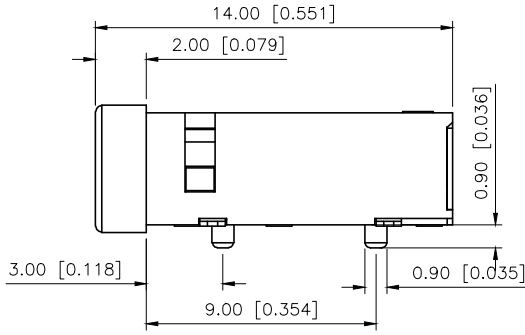
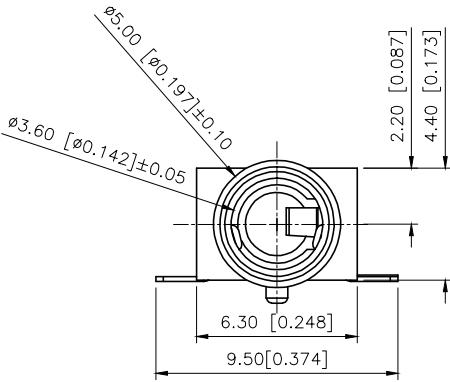
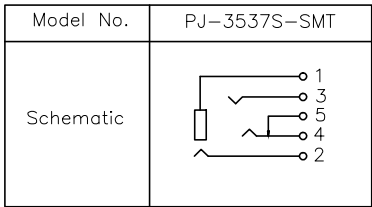


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.06.28	阿树



PCB LAYOUT TOP VIEW
TOLERANCES:±0.05



5	Housing	1	High temp.thermoplastic	Black
4	Terminal 4#	1	Copper alloy t=0.20	Au
3	Terminal 3#	1	Copper alloy t=0.20	Au
2	Terminal 2#	2	Copper alloy t=0.20	Au
1	Terminal 1#	1	Copper alloy t=0.20	Au
NO.	DESCRIPT	QTY	MATERIAL	PLATING

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	



DESIGN	阿树	VIEW:		MODEL TYPE:	3.5 PHONE JACK
CHECKED		UNIT:	mm/in	PART NO.:	PJ-3537S-SMT
APPROVED		SIZE:	A4	DWG NO.:	